

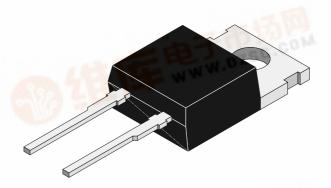


## Vishay Lite-On Power Semiconductor

# 7.5A Schottky Barrier Rectifiers

#### **Features**

- Schottky barrier chip
- Guard ring die construction for transient protection
- Low power loss, high efficiency
- High surge capability
- High current capability and low forward voltage drop
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection application
- Plastic material has UL flammability classification 94V–0



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## **Absolute Maximum Ratings**

 $T_i = 25^{\circ}C$ 

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Repetitive peak reverse voltage	Conditions	MBR730	V <sub>RRM</sub>	30	V
=Working peak reverse voltage		MBR735	=V <sub>RWM</sub> =V <sub>R</sub>	35	V
=DC Blocking voltage		MBR740		40	V
		MBR745		45	V
		MBR750		50	V
		MBR760		60	V
Peak forward surge current		Contract to	I <sub>FSM</sub>	150	Α
Average forward current	T <sub>C</sub> =125°C		I <sub>FAV</sub>	7.5	Α
Junction and storage temperature range			T <sub>j</sub> =T <sub>stg</sub>	<b>−</b> 65 <b>+</b> 150	°C

#### **Electrical Characteristics**

 $T_i = 25^{\circ}C$ 

Parameter	Test Conditions	Туре	Symbol	Min	Тур	Max	Unit
Forward voltage	I <sub>F</sub> =7.5A, T <sub>C</sub> 25°C	MBR730	V <sub>F</sub>			0.55	V
	I <sub>F</sub> =7.5A, T <sub>C</sub> 125°C	-MBR745	$V_{F}$	de	-4	0.70	V
	I <sub>F</sub> =7.5A, T <sub>C</sub> 25°C	MBR750	$V_{F}$		W. W.	0.70	V
	I <sub>F</sub> =7.5A, T <sub>C</sub> 125°C	-MBR760	$V_{F}$	- 4		0.75	V
Reverse current	T <sub>C</sub> =25°C	MBR730 -MBR745	I <sub>R</sub>			1.0	mA
· # (華电子	T <sub>C</sub> =125°C		I <sub>R</sub>			15	mA
	T <sub>C</sub> =25°C	MBR750 -MBR760	I <sub>R</sub>			1.0	mA
	T <sub>C</sub> =125°C		I <sub>R</sub>			50	mA
Diode capacitance	V <sub>R</sub> =4V, f=1MHz		C <sub>D</sub>		400		pF
Thermal resistance	T <sub>L</sub> =const.		R <sub>thJA</sub>		3.5		K/W
junction to ambient							
Voltage rate of change (Rated V <sub>R</sub> )			dV/dt		1000		V/μs

## **MBR730-MBR760**

## Vishay Lite-On Power Semiconductor



# **Characteristics** $(T_j = 25^{\circ}C \text{ unless otherwise specified})$

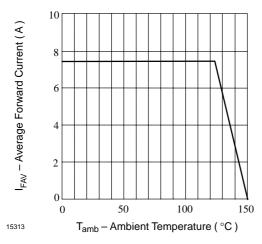


Figure 1. Max. Average Forward Current vs.
Ambient Temperature

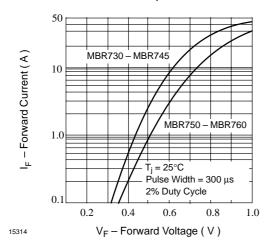


Figure 2. Typ. Forward Current vs. Forward Voltage

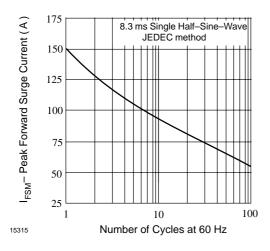


Figure 3. Max. Peak Forward Surge Current vs. Number of Cycles

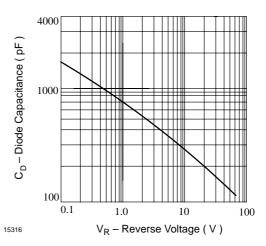


Figure 4. Typ. Diode Capacitance vs. Reverse Voltage

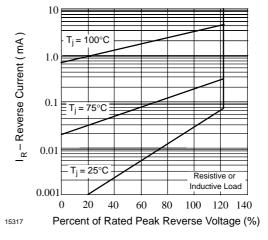


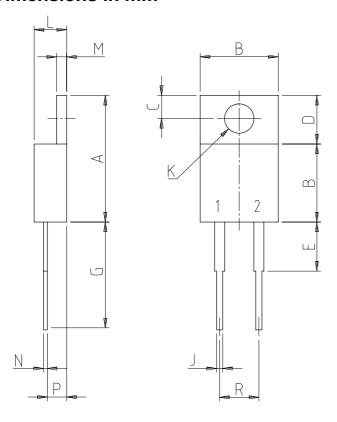
Figure 5. Typ. Reverse Current vs. Percent of Rated Peak Reverse Voltage

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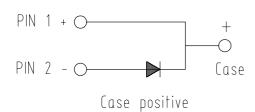


# Vishay Lite-On Power Semiconductor

### **Dimensions in mm**



TO-220AC				
Dim	Min	Max		
Α	14.22	15.88		
В	9.65	10.67		
	2.54	3.43		
D	5.84	6.86		
E	-	6.25		
G	12.70	14.73		
J	0.51	1.14		
K	Ø3.53	Ø4.09		
L	3.56	4.83		
М	1.14	1.40		
N	0.30	0.64		
Р	2.03	2.92		
R	4.83	5.33		
All Dimensions in mm				





14469

Case: Molded Plastic Polarity: See Diagram Approx. Weight: 2.3 grams Mounting Position: Any Marking: Tupe Number

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### MBR730-MBR760

## Vishay Lite-On Power Semiconductor



#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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